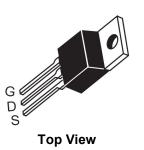
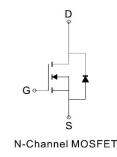


N-Channel Enhancement Mode Field Effect Transistor

- Features
 - N-channel, normal leve
 - Excellent gate charge x R_{DS(on)} product (FOM)
 - Very low on-resistance R_{DS(on)}
 - 175 °C operating temperature
 - Pb-free lead plating; RoHS compliant
 - Qualified according to JEDEC for target application
 - · Ideal for high-frequency switching and synchronous rectification
- Pin Configurations(TO220)





Absolute Maximum Ratings TA=25°C unless otherwise noted

Parameter	Symbol	Ratings	Unit		
Drain-Source Voltage		V _{DSS}	60	V	
Gate-Source Voltage	V _{GSS}	±20	V		
Drain Current	Continuous	I _D	6 ^(1A) 26 ^(1B)	A	
	Pulse	I DM	80		
(note1)	P _D	2.5 ^(1A)	w		
Total Power Dissipation		. D	50 ^(1B)		
Operating and Storage Junction Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Notes

- 1A、Surface Mounted on 1x1FR4 Board.
- 2. The value of PD is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25° C. The value in any given application depends on the user's specific board design. The current rating is based on the DC thermal resistance rating and PCB layout: A. Minimum footprint; B. With additional heat sink.
- 3. Repetitive rating, pulse width limited by junction temperature

- **FS2230BF**
- Product Summary

	V_{DS}	V_{GS}	Test Conditions	$R_{\text{DS(on)}}$	
	60V	+20V	5.5A@VGS=10V	30mR	
000	±20V	4.5A@ VGS=4V5	35mR		

/ 4



FS2230BF

Parameter ^(note2)	Symbol	Test Conditions	Min	Тур	Max	Unit
Drain–Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 uA	60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1	uA
Gate–Body Leakage	I GSS	V _{GS} = ± 20 V, V _{DS} = 0 V			±100	nA
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \text{ uA}$	1	1.4	3	V
Static Drain–Source On–Resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 5.5 A		30	41	mR
		V _{GS} = 4.5 V, I _D = 4.5 A		35	52	
Input Capacitance	C _{ISS}	V _{DS} = 10 V, V _{GS} = 0 V,		1180		pF
		F = 1MHz				
Output Capacitance	C _{oss}			170		
Reverse Transfer Capacitance	C _{RSS}			100		
Turn–On Delay Time	T _{D(ON)}	V _{GS} =10V, V _{DS} =30V,			25	nS
		R _L =5.4R,				
		R _{GEN} =3R, I _D =5.5A				
Turn–On Rise Time	T _R				70	
Turn–Off Delay Tim	T _{D(OFF)}	1			300	
Turn–Off Fall Time	T _F	1			150	
Diode Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = 2 A	0.5	0.77	1.0	V

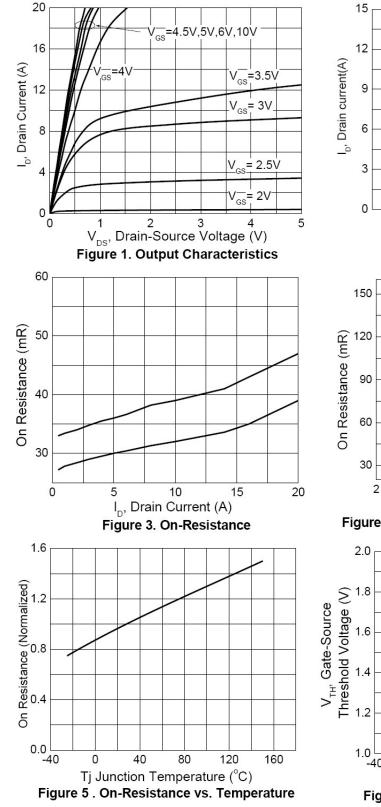
• Electrical Characteristics (T_A=25°C unless otherwise noted)

The value of PD is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25° C. The value in any given application depends on the user's specific board design. The current rating is based on the DC thermal resistance rating and PCB layout: A. Minimum footprint; B. With additional heat sink.

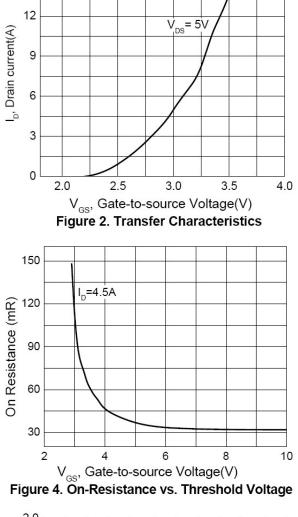
2. Repetitive rating, pulse width limited by junction temperature

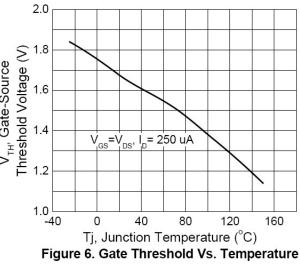


FS2230BF



• TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



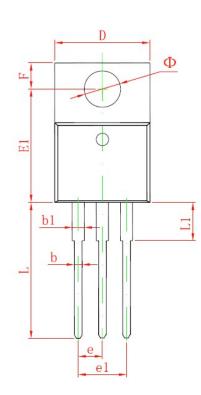


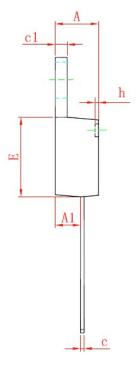




• Package Information

TO220





Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Мах	
A	4.470	4.670	0.176	0.184	
A1	2.520	2.820	0.099	0.111	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
E1	12.060	12.460	0.475	0.491	
е	2.540 TYP		0.100 TYP		
e1	4.980	5.180	0.196	0.204	
F	2.590	2.890	0.102	0.114	
h	0.000	0.300	0.000	0.012	
L	13.400	13.800	0.528	0.543	
L1	3.560	3.960	0.140	0.156	
Φ	3.735	3.935	0.147	0.155	